



MAY 28 2004

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SUPPLEMENTAL DECLARATION FOR REISSUE PATENT APPLICATION (37 CFR 1.175)	Attorney Docket No.	211838US2SRD RE
	First Named Inventor	Yasuo OHBA, et al.
	Serial Number	08/915,710
	Filing Date	July 27, 2001
	Group Art Unit	2815
	Examiner	Jerome Jackson, Jr.

I/We hereby declare that:

Every error in the patent which was corrected in the present reissue application, and which is not covered by the prior oath(s) and/or declaration(s) submitted in this application, arose without any deceptive intention on the part of the applicant.

I/We hereby declare that all statements made herein of my/our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. 1001, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full Name of sole or first inventor (given name, family name)

Yasuo Ohba

Signature

Yasuo Ohba

Date

May 13, 2004

Residence

Yokohama, Japan

Citizenship

Japan

Post Office Address 9-8-1-108 Hino Kounan-ku, Yokohama-shi, Kanagawa-ken, Japan 234-0051

Full Name of second joint inventor (given name, family name)

Aiko Hatano

Signature

Aiko Hatano

Date

May 20, 2004

Residence

Tokyo, Japan

Citizenship

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Post Office Address 2-20-5-804 Nishiwaseda, Shinjuku-ku, Tokyo-to, Japan 162-0051

Full Name of third joint inventor (given name, family name)

Signature

Date

Residence

Citizenship

Post Office Address

Full Name of fourth joint inventor (given name, family name)

Signature

Date

Residence

Citizenship

Post Office Address

☐ Additional joint inventors are named on separately numbered sheets attached hereto.



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DOCKET NO: 211836US25RD RE

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IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :
YASUO OHBA, ET AL. : EXAMINER: JEROME JACKSON JR.
SERIAL NO: 09/915,710 :
FILED: JULY 27, 2001 : GROUP ART UNIT: 2815
FOR: SEMICONDUCTOR DEVICE AND :
METHOD OF FABRICATING THE SAME :

37 CFR 1.175 REISSUE DECLARATION (CORRECTED)

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

I. 37 CFR 1.172 Declaration by the Assignee

The written consent to this reissue application by the assignee owning the entire interest in the patent has been previously filed.

II. 37 CFR 1.175

A. 37 CFR 1.175(a)

1. 37 CFR 1.63(a)(1)

This declaration is executed in accordance with 37 CFR 1.68. Specifically, the undersigned have been warned that willful false statements and the like are punishable by fine or imprisonment, or both (18 U.S.C. 1001), and willful false statements may jeopardize the validity of this application or any patent issuing thereon. All of the undersigned's statements based upon personal knowledge are true, and all of the undersigned's statements made on information and belief are believed to be true.

2. 37 CFR 1.63(a)(2)

There are two inventors. The full name of the first inventor is Yasuo Ohba. The full name of the second inventor is Ako Hatano. Yasuo Ohba and Ako Hatano are joint inventors of the inventions claimed.

3. 37 CFR 1.63(a)(3)

Yasuo Ohba and Ako Hatano are both citizens of Japan.

4. 37 CFR 1.63(a)(4)

The inventors believe that they are the original and first inventors of the subject matter which is claimed and for which a patent is sought.

5. 37 CFR 1.63(b)(1)

This declaration is directed to the application for the reissue of U.S. 5,929,466, filed July 27, 2001.

6. 37 CFR 1.63(b)(2)

The inventors have each reviewed and understand the contents of the specification, including the claims, as amended in the reissue application filed July 27, 2001.

7. 37 CFR 1.63(b)(3)

The inventors each acknowledge their duty to disclose to the U.S. Patent Office all information known to him to be material to patentability as defined in 37 CFR 1.56.

8. 37 CFR 1.63(c)(1)

Yasuo Ohba's residence and Post Office address is 3-8-1-109 Hino Kounan-ku, Yokohama-shi, Kanagawa-ken, Japan 234-0051.

Ako Hatano's residence and Post Office address is 2-20-5-804 Nishiwaseda, Shinjuku-ku, Tokyo-to, Japan 162-0051.

9. 37 CFR 1.63(c)(2)

The foreign applications are Japanese Patent No. 6-038157 filed March 9, 1994 and Japanese Patent No. 7-000704 filed January 6, 1995. Priority is claimed from these applications.

10. 37 CFR 1.63(d)

This section is not applicable.

11. 37 CFR 1.63(e)

This section is not applicable.

B. 37 CFR 1.175(a)(1)

The applicants believe the original patent to be wholly or partly inoperative or invalid by reason of the patentee claiming more or less than the patentee had the right to claim in the patent. The applicants seek to broaden the scope of the original claims. One error was the failure in U.S. 5,929,466 to claim the subject matter of reissue claim 11,

namely, a semiconductor device having, in addition to the subject matter of claim 1 of 5,929,466, a substrate, said buffer semiconductor layer being formed on said substrate, and said pinholes comprising exposed portions of said substrate through said buffer.

C. 37 CFR 1.175(a)(2)

All errors being corrected in the reissue application arose without any deceptive intention on the part of the applicants.

III. 37 CFR 1.175(b)

Every error addressed by the claims filed in the reissue application arose without any deceptive intention on the part of the applicant.

IV. 37 CFR 1.175(c)

This section provides no additional requirements.

V. 37 CFR 1.175(d)

This section is not applicable.

VI. Jurat

The inventors each declare under penalty of perjury of the laws of the United States that the foregoing is true and correct.

Yasuo Ohba Yasuo Ohba
May 13, 2004 Date Signed

Ako Hatano Ako Hatano
May 20, 2004 Date Signed